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Dan J. Clingman

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Contents

v	Authors
vii	Conference Committee

SESSION 1	ENERGY HARVESTING/SENSORS I
10166 02	A forty-year history of fiber optic smart structures (Invited Paper) [10166-1]
10166 03	Examination of single-substance multiphase material distribution in a cylindrical container using acoustic wavenumber spectroscopy [10166-2]
10166 04	A piezoelectric shock-loading response simulator for piezoelectric-based device developers [10166-3]
SESSION 2	ENERGY HARVESTING/SENSORS II
10166 05	Piezoelectric-based hybrid reserve power sources for munitions [10166-4]
10166 06	Modal analysis of a loaded tire with non-contact measurements and piezoelectric excitation [10166-5]
10166 07	Wearable Spiral Passive Electromagnetic Sensor (SPES) glove for sign language recognition of alphabet letters and numbers: a preliminary study [10166-6]
10166 08	A new class of monolithic seismometers and accelerometers for commercial and industrial applications: the UNISA folded pendulum [10166-7]
10166 09	The development of two Broadband Vibration Energy Harvesters (BVEH) with adaptive conversion electronics [10166-8]
SESSION 3	SMART MATERIALS AND APPLICATIONS I
10166 0B	Bimorph-driven synthetic jet actuators optimized for various piezoelectric materials using a low-order model [10166-10]
10166 0C	Self-tuning tuned mass damper (TMD) [10166-11]
10166 0D	An electro-dynamic 3-dimensional vibration test bed for engineering testing [10166-12]
SESSION 4	SMART MATERIALS AND APPLICATIONS II
10166 0E	Preliminary aeroelastic assessment of a large aeroplane equipped with a camber-morphing aileron [10166-13]

10166 0F **Touchscreen surface based on interaction of ultrasonic guided waves with a contact impedance** [10166-14]

10166 0G **Magnetorheological stabilizer bar for ground vehicles** [10166-15]

SESSION 5 SMART MATERIALS AND APPLICATIONS III

10166 0H **Challenges and the state of the technology for printed sensor arrays for structural monitoring** [10166-16]

10166 0I **Reinforcing cementitious structures by pH activated in-situ shrinking microfiber** [10166-17]

10166 0J **A portable integrated system to control an active needle** [10166-18]

10166 0K **Auto-Gopher-II: an autonomous wireline rotary-hammer ultrasonic drill** [10166-19]

10166 0L **Experimental validation of a true-scale morphing flap for large civil aircraft applications** [10166-20]

Authors

Numbers in the index correspond to the last two digits of the seven-digit citation identifier (CID) article numbering system used in Proceedings of SPIE. The first five digits reflect the volume number. Base 36 numbering is employed for the last two digits and indicates the order of articles within the volume. Numbers start with 00, 01, 02, 03, 04, 05, 06, 07, 08, 09, 0A, 0B...0Z, followed by 10-1Z, 20-2Z, etc.

Ahmed, Riaz, 0D	Noviello, M. C., 0L
Amendola, Gianluca, 0E	O'Dowd, Niall M., 03
Amoroso, Francesco, 0E, 0L	Palumbo, Rita, 0E
Anderson, Nickolas, 0H	Paulsen, Gale L., 0K
Arena, Maurizio, 0E, 0L	Pecora, Rosario, 0E, 0L
Ashrafiuon, Hashem, 0J	Quaegebeur, Nicolas, 0F
Badescu, Mircea, 0K	Rastegar, J., 04, 05
Bai, Xian-Xu, 0G	Rea, F., 0L
Banerjee, Sourav, 0D	Rees, John R., 03
Bao, Xiaoqi, 0K	Saadatz, Mohammad Nasser, 0D
Bar-Cohen, Yoseph, 0K	Saadatz, Mohammadsadegh, 0D
Barone, F., 08	Sarret, Philippe, 0F
Beaudet, Nicolas, 0F	Sassoon, Aaron M., 0B
Bland, Scott, 0H	Scheel, Ingrid Udd, 02
Brzozowski, Daniel P., 0B	Shen, Sheng, 0G
Chesin, Jacob, 0K	Sherit, Stewart, 0K
Clingman, Dan J., 09	Tarazaga, Pablo A., 06
DeMott, Robert, 0H	Thiesen, Jack, 09
Dimino, Ignazio, 0E	Udd, Eric, 02
Feng, Z., 04	Xu, Shi-Xu, 0G
Ferhat, Ipar, 06	Yu, Tianliang, 0B
Flynn, Eric B., 03	Zacny, Kris, 0K
Giordano, G., 08	
Griffin, Steven F., 0B, 0C	
Huston, Dryver R., 0I	
Iervolino, Onorio, 07	
Jackson, Shannon, 0K	
Joshi, Shiv, 0H	
Jursich, Gregory, 0H	
Kim, Daniel, 0K	
Kim, Eric S., 0I	
Konh, Bardia, 0J	
Koskelo, Elise Anne C., 03	
Kwok, P., 05	
Lee, Hyeong Jae, 0K	
Lee, Patrick C., 0I	
Lesieutre, George A., 0B	
Masson, Patrice, 0F	
Mellerowicz, Bolek, 0K	
Meo, Michele, 07	
Motalleb, Mahdi, 0J	

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- 3 Smart Materials and Applications I
Bardia Konh, University of Hawai'i at Manoa (United States)
- 4 Smart Materials and Applications II
Bardia Konh, University of Hawai'i at Manoa (United States)
- 5 Smart Materials and Applications III
Christopher S. Lynch, University of California, Los Angeles (United States)